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ABSTRACT

The invention provides a method for permanently physically and electrically attaching the electrically conductive contacts of a first component in a RFID device, such as a smart card or smart inlay, to the electrically conductive contacts of a second component of the device. Attachment is made between the first and second components of the device by codepositing metal and electrically conductive hard particles upon the conductive contacts of either the first or second components and using a non-conductive adhesive to provide permanent bond between the components and their conductive contacts. Components of an RFID device may include, for example, a memory chip, a microprocessor chip, a transceiver, or other discrete or integrated circuit device, a chip carrier, a chip module, and a conductive area, e.g., an antenna.